



Material Composition Declaration

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This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.

Adobe Reader version 7.0.5 is required to complete this declaration.

1752-1 1.1	IPC Web Site for Information on IPC-1752 Standard http://www.ipc.org/IPC-175x	Form Type * Distribute	Declaration Class * Class 4 - RoHS Yes/No, JIG Format Substances, Mfg Info
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Supplier Information

Company Name * CHiL Semiconductor	Company Unique ID	Unique ID Authority	Response Date * 2010-10-25	Response Document ID				
Contact Name * Manu Jain	Title - Contact	Phone - Contact * 978-640-0011	Email - Contact * quality@chilsemi.com					
Authorized Representative * Manu Jain	Title - Representative	Phone - Representative * 978-640-0011	Email - Representative * quality@chilsemi.com		Supplier Comments or URL for Additional Information			
Requester Item Number	Mfr Item Number	Mfr Item Name	Effective Date	Version	Manufacturing Site	Weight *	UOM	Unit Type
	CHL8510	CHL8510	2010-10-25			22.5	mg	Each
Alternate Recommendation			Alternate Item Comments					

Manufacturing Process Information

Terminal Plating / Grid Array Material Matte Tin (Sn)	Terminal Base Alloy CU Alloy	J-STD-020 MSL Rating 1	Peak Process Body Temperature 257 C	Max Time at Peak Temperature 25 seconds	Number of Reflow Cycles 1
Comments Does not contain PFOS					

* Required Field

Save the fields in this form to a file

Export Data

Import fields from a file into this form

Import Data

Locked

RoHS Material Composition Declaration

Declaration Type *

Custom

RoHS Directive 2002/95/EC **RoHS Definition:** Quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (100 PPM) of homogeneous material for Cadmium

Subject to the limitations below, CHiL Semiconductor Corporation certifies the following information as of the document date.

1. CHiL products designated "ROHS Compliant" comply with the European Unions Directive on the Restriction of the Use of Hazardous Substances 2002/95/EC ("RoHS").
2. CHiL products do not contain and are not manufactured with ozone depleting compounds.
3. CHiL products do not contain substances identified by the European Chemical Agency ("ECHA") as substances of very high concern ("SVHC") per REACH Regulation (EC) No 1907/2006. CHiL also complies with use restrictions as stipulated in Annex XVII of REACH.
4. CHiL's list of banned and reportable substances and management system is based on the current version of the Joint Industrial Guide, JIG-101.

CHiL has taken commercially reasonable steps to provide representative and accurate information but may not have independently verified information provided or conducted chemical analysis of incoming materials. Equivalent compliant materials may have been substituted for those stated herein. Material concentrations are the maximum expected concentration of the substance in the device and may not represent the actual concentration. CHiL and its suppliers consider certain limited information to be confidential and thus CAS numbers and other limited information may not be available for release.

CHiL ACCEPTS NO DUTY TO NOTIFY USERS OF THIS DECLARATION OF UPDATES OR CHANGES TO THIS DECLARATION

RoHS Declaration *

1 - Item(s) does not contain RoHS restricted substances per the definition above

Supplier Acceptance *

Accepted

Exemptions: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.

Declaration Signature

Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.

Supplier Digital Signature

Joint Industry Guide (JIG) Material Composition Declaration for Electronic Products

Instructions: Declare whether the item substances exceed the threshold levels shown in the table and report accordingly. Where threshold levels include the words "intentionally added", substances must be declared if they are added intentionally, regardless of threshold level. For each RoHS substance, identified with dual asterisks (**), report the worst case PPM at the homogeneous material level and optionally the total weight of the substance in the item. For all remaining (non-RoHS) JIG A & B substances, and any additional substances, report the total weight and optionally the PPM at the part level for each item.

				JIG A autofill - No	JIG B autofill - No	All autofill - No	
JIG	Category Name	Threshold Level	Above Threshold Level?	If yes, enter total weight and worse case PPM			Description of Use
Level	As defined in the Joint Industry Guide	Intentionally added or PPM	Yes/No	Weight	UoM	PPM	
A	Asbestos	Intentionally Added	No				
A	Certain Azo colorants	Intentionally Added	No				
A	Cadmium/Cadmium Compounds **	75 PPM or Intentionally Added	No				
A	Hexavalent Chromium/Hexavalent Chromium Compounds **	1000 PPM or Intentionally Added	No				
A	Lead/Lead Compounds **	1000 PPM or Intentionally Added	No				
A	Lead/Lead Compounds - PVC Cables and Wires Only **	300 PPM	No				
A	Mercury/Mercury Compounds **	1000 PPM or Intentionally Added	No				
A	Ozone Depleting Substances - Class I (CFCs, HBFCs, etc.)	Intentionally Added	No				
A	Ozone Depleting Substances - Class II (HCFCs)	1000 PPM	No				
A	Polybrominated Biphenyls (PBBs) **	1000 PPM or Intentionally Added	No				
A	Polybrominated Diphenylethers (PBDEs) **	1000 PPM or Intentionally Added	No				
A	Polychlorinated Biphenyls (PCBs)	Intentionally Added	No				
A	Polychlorinated Naphthalenes (> 3 chlorine atoms)	Intentionally Added	No				
A	Radioactive Substances	Intentionally Added	No				
A	Certain Shortchain Chlorinated Paraffins	Intentionally Added	No				
A	Tributyl Tin (TBT) and Triphenyl Tin (TPT)	Intentionally Added	No				
A	Tributyl Tin Oxide (TBTO)	Intentionally Added	No				
B	Antimony/Antimony Compounds	1000 PPM	No				
B	Arsenic/Arsenic Compounds	1000 PPM	No				
B	Beryllium/Beryllium Compounds	1000 PPM	No				
B	Bismuth/Bismuth Compounds	1000 PPM	No				
B	Brominated Flame Retardants (other than PBBs or PBDEs)	1000 PPM	No				
B	Nickel (external applications only)	1000 PPM	No				
B	Certain Phthalates	1000 PPM	No				
B	Selenium/Selenium Compounds	1000 PPM	No				
B	Polyvinyl Chloride (PVC)	1000 PPM	No				

OTHER Material Composition Declaration

Requester Instructions: The requester can optionally include additional substances that must be declared for the item on this form. This is in addition to JIG Level A and JIG Level B substances. The requester should enter additional substances as well as the threshold levels that specify the substance at the item level.

Supplier Instructions: Explicitly declare whether the item exceed the threshold level by selecting Yes or No. If the maximum concentration of any substance exceeds the threshold levels defined by the requester, then the substance content must be reported in total weight and/or worst case PPM, along with a description of material use.

JIG	Category Name	Threshold Level
Other	As defined by the Supplier	Defined by the Supplier
+ -		
Add Other Material Composition to JIG Tab		Clear Other Material Composition in JIG Tab